

Nickel/Li-Ion Development System

Control of On-Board PNP Switch-Mode Regulator

Features

- bq2005 fast charge control evaluation and development for NiMH, NiCd and Li-Ion
- Charge current (up to 2.0A) sourced from an on-board switch mode regulator to 100kHz
- Sequential fast charge control for one or two battery packs containing five NiCd or NiMH cells or two Li-Ion cells
- Fast charge termination by $\Delta T/\Delta t$, PVP maximum time, temperature, and voltage, and minimum current (for voltage regulated Li-Ion charging)
- Charging status displayed on one dual color LED per battery pack
- Jumper configurable for charge time, hold-off period, top-off rate, and pulse trickle rate and frequency
- Discharge-before-charge control with push-button switch or auto discharge-before-charge with jumper

General Description

The DV2005S3 Development System provides a dual-chemistry development environment for the bq2005 Dual-Battery Fast Charge IC. The DV2005S3 incorporates a bq2005 and a buck-type switch-mode regulator to provide fast charge control for two battery packs containing five NiCd or NiMH cells or two Li-Ion cells.

Fast charge for Nickel chemistry batteries is terminated by any of the following: $\Delta T/\Delta t$, PVP, maximum charge time, maximum temperature, and maximum voltage. Li-Ion fast charging is accomplished by a current limited phase followed by a voltage regulated (within 1%) phase, and terminated by a minimum current criterion backed up by maximum voltage and maximum time.

The user supplies a power supply and batteries. Please review the bq2005 data sheet before using the DV2005S3 board. The user configures the DV2005S3 for maximum time, hold-off period, top-off rate, pulse trickle rate and frequency, and manual (push button switch) or auto discharge-before-charge.



Contents

- 1 DV2005S3 printed circuit board containing:
 - a) bq2005 PDIP IC
 - b) Switch-mode current regulator
 - c) All programming jumpers
 - d) 4 NTC thermistors
- 1 bq Charge Configuration diskette
- 1 Documentation kit including user's manual, schematics and datasheets

DV2005S3

Connection Descriptions

J1

DC+	DC power supply high side input
DC-	DC power supply low side input

J2

SELCA	Pack A chemistry select
THERMA	Pack A high side thermistor connection
SNSA	Pack A negative battery terminal and thermistor connections
BATA+	Pack A positive battery terminal and high side discharge load connection
LOADA-	Pack A low side discharge load connection
INHA	Pack A logic level inhibit input

J3

SELCB	Pack B chemistry select
THERMB	Pack B high side thermistor connection
SNSB	Pack B negative battery terminal and thermistor connections
BATB+	Pack B positive battery terminal and high side discharge load connection
LOADB-	Pack B low side discharge load connection
INH B	Pack B logic level inhibit input

Fixed Configuration

The DV2005S3 board has the following fixed characteristics:

- V_{CC} (4.75-5.25V) is regulated on-board from the supply at connector J1 DC+.
- LED1_{A/B} and LED2_{A/B} indicate charge status per battery pack (A/B).

Charge begins on the later application of the battery or DC, which provides V_{CC} to the bq2005. Charging of the two battery packs is sequential. See the bq2005 datasheet for details.

As shipped from Benchmarq, the DV2005S3 buck-type switch-mode regulator is configured to a charging current of 2.0A. This current level is controlled by the value of sense resistor R_{SNS} by the relationship:

$$I_{CHG} = \frac{0.225V}{R_{SNS}}$$

The inductor is configured for a maximum of 2.0 Amps and should not be adjusted without consulting Benchmarq.

With the provided NTC thermistor connected between THERMA/B and SNSA/B, the thermal threshold values are: LTF = 0°C, HTF = 40°C, TCO = 60°C. The $\Delta T/\Delta t$ setting at 30°C ($T_{\Delta T}$) is: minimum = 0.82°C/minute, typical = 1.10°C/ minute.

Jumper-Selectable Configuration

Inhibit (JP1): Enables/disables fast charge inhibit. Set across pins 1 and 2 to enable fast charging. Set across pins 2 and 3 to disable fast charge. Board is shipped with inhibit disabled.

Number of Cells (JP2-4): A resistor-divider network is provided to select 3, 6, or 9 Nickel cells or 1, 2, or 3 Li-Ion cells. The resulting resistor value equals $(N/2 - 1)$ cells. Board is shipped configured for 3 NiCd/NiMH or 1 Li-Ion cell (jumper on JP4).

Closed Jumper	NiCd/NiMH	Li-Ion
JP2	9	3
JP3	6	2
JP4	3	1

Maximum Time Out (JP5-6): These jumpers configure the pins TM₁ and TM₂ (respectively) on the bq2005 to set Maximum Time Out (MTO) limit, Hold-Off Time, Top-Off enable/disable, and Pulse Trickle rate and period. See Table 3 in the bq2005 datasheet for the configuration of these pins for various values. Set the jumper across pins 1 and 2 to pull the line high, 2 and 3 to pull the line low, and remove the jumper to float the input. Boards are shipped with both lines set high.

Auto Discharge-Before-Charge (JP7): Enables/disables automatic discharge-before-charge. Set across pins 1 and 2 to enable auto discharge; set across pins 2 and 3 to disable. If disabled, discharge before charge is activated only by the manual push button. Boards are shipped with auto discharge disabled.

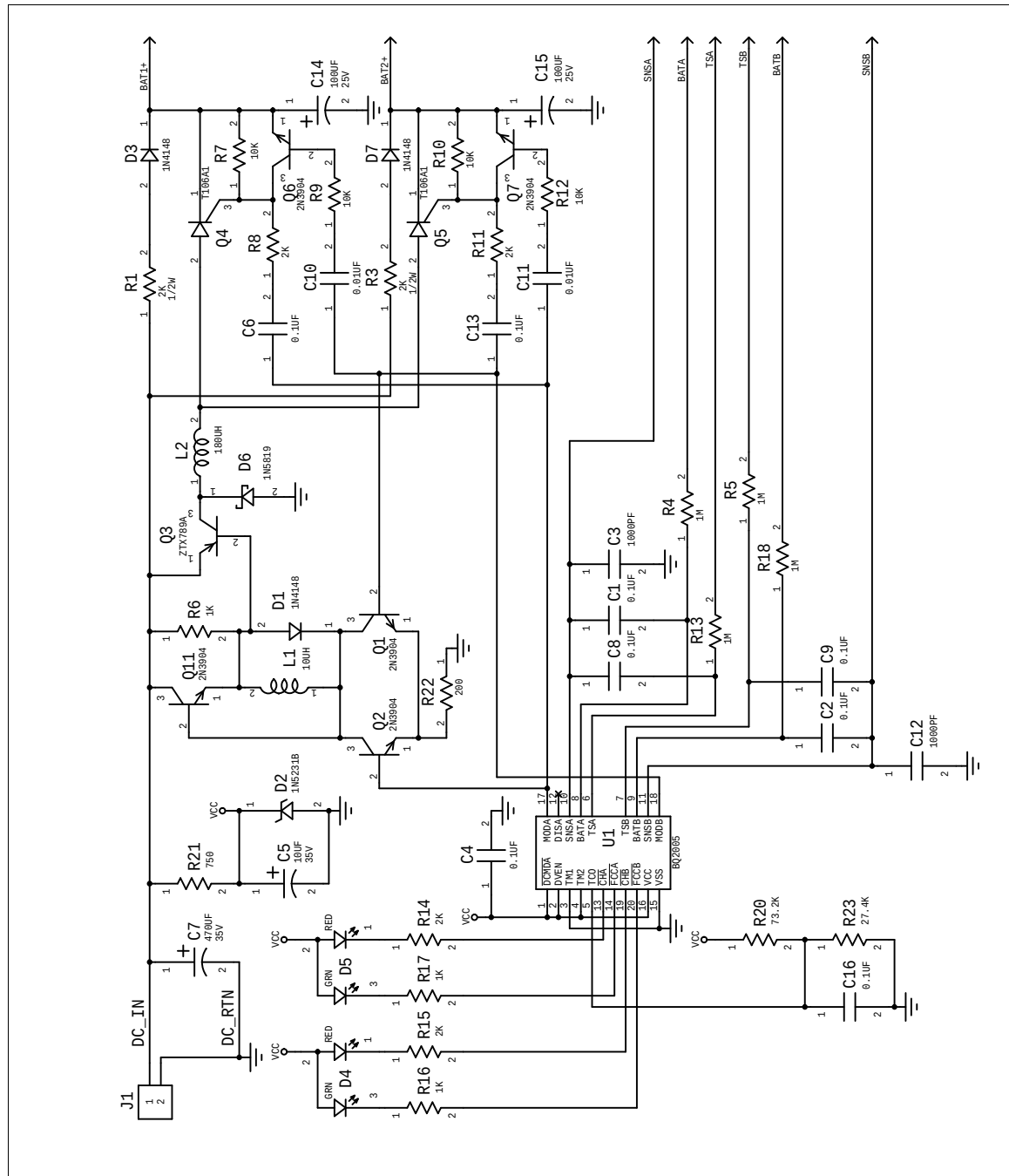
Temperature Disable: Connecting a 10kΩ resistor between TS_{A/B} and SNS_{A/B} disables temperature sensing for pack A or pack B respectively.

Setup Procedure

1. Configure all jumpers to their desired settings prior to applying batteries or power to the DV2005S3.
2. Connect the provided thermistors or 10k Ω resistors between TS_A and SNS_A and TS_B and SNS_B.
3. Connect the discharge loads between BAT_{A/B} + and LOAD_{A/B} - for packs A and B, respectively.
4. Attach the battery packs between BAT_{A/B} + and SNS_{A/B} for packs A and B, respectively. For Nickel packs, SELC should float. For Li-Ion packs, SELC must be connected to BAT_{A/B} + to operate properly.
5. Attach an appropriate DC current source to DC+ and DC- on connector J1.

DV2005S3

DV2005S3 Board Schematic



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